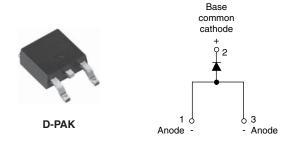


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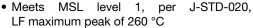
Vishay Semiconductors

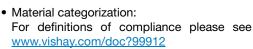
## Surface Mount Fast Soft Recovery Rectifier Diode, 8 A



PRODUCT SUMMARY						
Package	D-PAK (TO-252AA)					
I <sub>F(AV)</sub>	8 A					
V <sub>R</sub>	1000 V, 1200 V					
V <sub>F</sub> at I <sub>F</sub>	1.3 V					
I <sub>FSM</sub>	150 A					
t <sub>rr</sub>	80 ns					
T <sub>J</sub> max.	150 °C					
Diode variation	Single die					
Snap factor	0.6					

#### **FEATURES**









RoHS

#### **APPLICATIONS**

- Output rectification and freewheeling diode in inverters, choppers and converters
- Input rectifications where severe restrictions on conducted EMI should be met

#### **DESCRIPTION**

The VS-8EWF..S-M3 fast soft recovery rectifier series has been optimized for combined short reverse recovery time, low forward voltage drop and low leakage current.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL CHARACTERISTICS VALUES U									
I <sub>F(AV)</sub>	Sinusoidal waveform	8	A						
V <sub>RRM</sub>		1000/1200	V						
I <sub>FSM</sub>		150	A						
V <sub>F</sub>	8 A, T <sub>J</sub> = 25 °C	1.3	V						
t <sub>rr</sub>	1 A, 100 A/μs	80	ns						
T <sub>J</sub>	Range	- 40 to 150	°C						

VOLTAGE RATINGS								
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I <sub>RRM</sub> AT 150 °C mA					
8EWF10SPbF	1000	1100	4					
8EWF12SPbF	1200	1300	4					

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	VALUES	UNITS						
Maximum average forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 94 °C, 180° conduction half sine wave	8					
Maximum peak one cycle	I <sub>FSM</sub>	10 ms sine pulse, rated V <sub>RRM</sub> applied	125	Α				
non-repetitive surge current		10 ms sine pulse, no voltage reapplied	150					
Mar. 100 121 for first	l <sup>2</sup> t	10 ms sine pulse, rated V <sub>RRM</sub> applied	78	A <sup>2</sup> s				
Maximum I <sup>2</sup> t for fusing	I <sup>-</sup> l	10 ms sine pulse, no voltage reapplied	110	A-S				
Maximum l²√t for fusing	I²√t	t = 0.1 to 10 ms, no voltage reapplied	1100	A²√s				



# **VS-8EWF..SPbF Soft Recovery Series**

# Vishay Semiconductors

ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS			
Maximum forward voltage drop	$V_{FM}$	8 A, T <sub>J</sub> = 25 °C		1.3	V			
Forward slope resistance	r <sub>t</sub>	T <sub>.1</sub> = 150 °C		25.6	mΩ			
Threshold voltage	V <sub>F(TO)</sub>	1j = 150 C		0.93	V			
Maximum rayaraa laakaga aurrant	1	T <sub>J</sub> = 25 °C	V Patad V	0.1	m A			
Maximum reverse leakage current	I <sub>RM</sub>	T <sub>J</sub> = 150 °C	V <sub>R</sub> = Rated V <sub>RRM</sub>	4	mA			

RECOVERY CHARACTERISTICS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	· •				
Reverse recovery time	t <sub>rr</sub>	In at 8 And	270	ns	I <sub>FM</sub> t				
Reverse recovery current	I <sub>rr</sub>	I <sub>F</sub> at 8 A <sub>pk</sub> 25 A/µs T <sub>J</sub> = 25 °C	4.2	Α	$t_a \mid t_b$				
Reverse recovery charge	Q <sub>rr</sub>		$T_J = 25 ^{\circ}\text{C}$	1	μC	di / Q <sub>rr</sub>			
Snap factor	S		0.6		l V I <sub>rr</sub>				

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 40 to 150	°C			
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation	2.5	°C/W			
Typical thermal resistance, junction to ambient (PCB mount)	R <sub>thJA</sub> (1)		50	C/VV			
Soldering temperature	T <sub>S</sub>	For 10 seconds	260	°C			
Approximate weight			1	g			
Approximate weight			0.03	OZ.			
Marking device		Case style D-PAK (TO-252AA)	8EWF	12S			

#### Note

<sup>(1)</sup> When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994

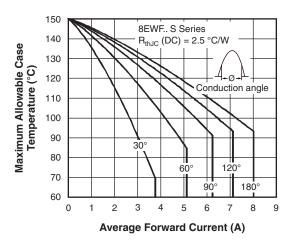


Fig. 1 - Current Rating Characteristics

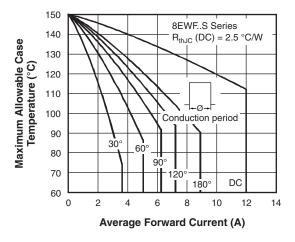


Fig. 2 - Current Rating Characteristics

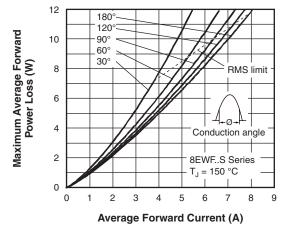


Fig. 3 - Forward Power Loss Characteristics

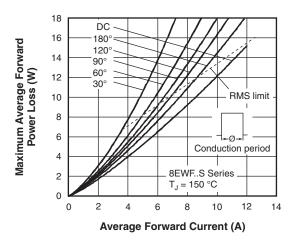


Fig. 4 - Forward Power Loss Characteristics

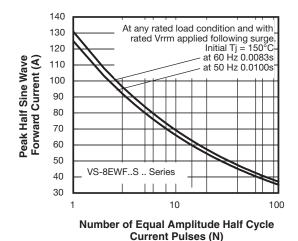


Fig. 5 - Maximum Non-Repetitive Surge Current

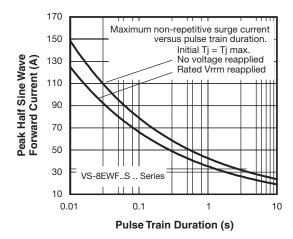


Fig. 6 - Maximum Non-Repetitive Surge Current

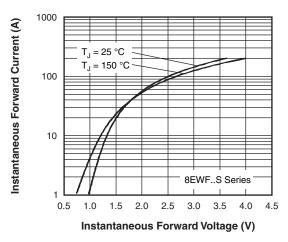


Fig. 7 - Forward Voltage Drop Characteristics

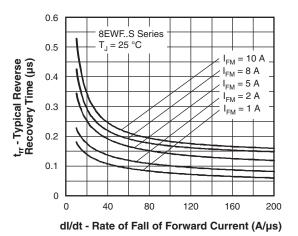


Fig. 8 - Recovery Time Characteristics, T<sub>J</sub> = 25 °C

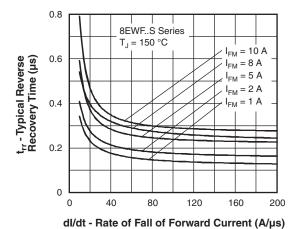


Fig. 9 - Recovery Time Characteristics, T<sub>J</sub> = 150 °C

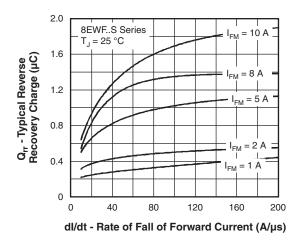
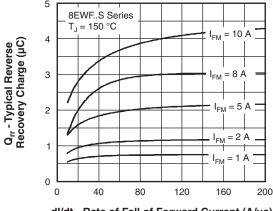
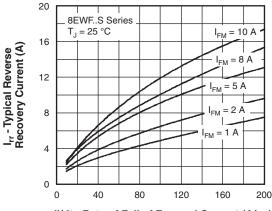


Fig. 10 - Recovery Charge Characteristics, T<sub>J</sub> = 25 °C



dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 11 - Recovery Charge Characteristics, T<sub>J</sub> = 150 °C



dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 12 - Recovery Current Characteristics, T<sub>J</sub> = 25 °C

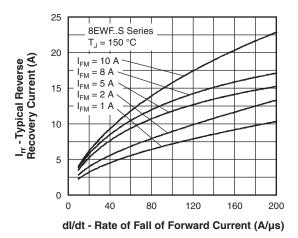


Fig. 13 - Recovery Current Characteristics, T<sub>J</sub> = 150 °C

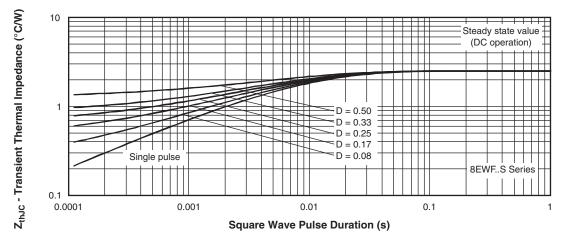


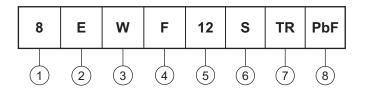
Fig. 14 - Thermal Impedance  $Z_{thJC}$  Characteristics

## **VS-8EWF..SPbF Soft Recovery Series**

Vishay Semiconductors

#### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Current rating (8 = 8 A)

2 - Circuit configuration:

E = Single diode

3 - Package:

W = D-PAK

4 - Type of silicon:

F = Fast soft recovery rectifier

- Voltage code x 100 = V<sub>RRM</sub> - 10 = 1000 V 12 = 1200 V

6 - S = Surface mountable

7 - • TR = Tape and reel

• TRR = Tape and reel (right oriented)

• TRL = Tape and reel (left oriented)

8 - None = Standard production

• PbF = Lead (Pb)-free

LINKS TO RELATED DOCUMENTS						
Dimensions <u>www.vishay.com/doc?95016</u>						
Part marking information	www.vishay.com/doc?95059					
Packaging information	www.vishay.com/doc?95033					
SPICE model	www.vishay.com/doc?95552					



**INCHES** 

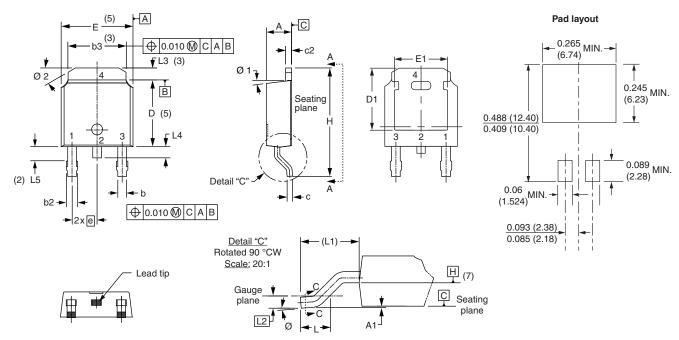
MIN.

MAX.

**NOTES** 

# **D-PAK (TO-252AA)**

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIN	MILLIMETERS		HES	NOTES	SYMBOL	MILLIN	IETERS				
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	NOTES	NOTES	NOTES	STIVIDOL	MIN.	MAX.
Α	2.18	2.39	0.086	0.094		е	2.29	BSC				
A1	-	0.13	-	0.005		Н	9.40	10.41				
b	0.64	0.89	0.025	0.035		L	1.40	1.78				
b2	0.76	1.14	0.030	0.045		L1	2.74	BSC				
b3	4.95	5.46	0.195	0.215	3	L2	0.51	BSC				
С	0.46	0.61	0.018	0.024		L3	0.89	1.27				
c2	0.46	0.89	0.018	0.035		L4	-	1.02				
D	5.97	6.22	0.235	0.245	5	L5	1.14	1.52				
D1	5.21	-	0.205	-	3	Ø	0°	10°				
Е	6.35	6.73	0.250	0.265	5	Ø1	0°	15°				
E1	4.32	-	0.170	-	3	Ø2	25°	35°				

	е	2.29 BSC		0.090 BSC		
	Н	9.40	10.41	0.370	0.410	
	L	1.40	1.78	0.055	0.070	
	L1	2.74	BSC	0.108	REF.	
	L2	0.51	BSC	0.020	BSC	
	L3	0.89	1.27	0.035	0.050	3
	L4	-	1.02	-	0.040	
	L5	1.14	1.52	0.045	0.060	2
	Ø	0°	10°	0°	10°	
	Ø1	0°	15°	0°	15°	
	Ø2	25°	35°	25°	35°	

#### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- Section C C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip
- Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Dimension b1 and c1 applied to base metal only
- (7) Datum A and B to be determined at datum plane H
- Outline conforms to JEDEC outline TO-252AA



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